Notice of References Cited Application/Control No. 10/623,783 Applicant(s)/Patent Under Reexamination OMAN ET AL. Examiner Michael V. Datskovskiy 2835 Applicant(s)/Patent Under Reexamination OMAN ET AL. Page 1 of 1

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A copy of this reference is not being furnished with this Office action. (See MPEP § 707.05(a).)

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Dates in MM-YYYY format are publication dates. Classifications may be US or foreign.